



PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR

**TYPE: 50V, 100V, 500V, 1KV, 2KV, TEMPERATURE
COMPENSATING CAPACITOR**

CUSTOMER: _____

DOC. NO.: POE-D01-00-E-15

Ver.: 15

APPROVED BY CUSTOMER

VENDOR :

WALSIN TECHNOLOGY CORPORATION

566-1, KAO SHI ROAD, YANG-MEI
TAO-YUAN, TAIWAN

PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

NO.277,HONG MING ROAD,EASTERN SECTION,
GUANG ZHOU ECONOMIC AND TECHNOLOGY
DEVELOPMENT ZONE,CHINA



MAKER : PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

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Record of change

Date	Version	Description	page																																																												
2008.6.3	1	1. D08-00-E-14 (before) → POE-D01-00-E-01 (1 st edition)																																																													
2008.8.22	2	1.Revised diameter as below : <table border="1" style="width: 100%; border-collapse: collapse; margin-top: 10px;"> <thead> <tr> <th style="width: 25%;">Before</th> <th style="width: 25%;">Now</th> <th style="width: 25%;">Before</th> <th style="width: 25%;">Now</th> </tr> </thead> <tbody> <tr> <td>CH5000R5X040*</td> <td>not available</td> <td>SL500181X060*</td> <td>SL500181X050*</td> </tr> <tr> <td>CH1010R5X040*</td> <td>not available</td> <td>SL500241X070*</td> <td>SL500241X060*</td> </tr> <tr> <td>CH501360X050*</td> <td>CH501360X060*</td> <td>SL500361X080*</td> <td>SL500361X070*</td> </tr> <tr> <td>CH501620X080*</td> <td>CH501620X060*</td> <td>SL500391X080*</td> <td>SL500391X070*</td> </tr> <tr> <td>CH501680X080*</td> <td>CH501680X060*</td> <td>SL101181X060*</td> <td>SL101181X050*</td> </tr> <tr> <td>CH501750X080*</td> <td>CH501750X060*</td> <td>SL101241X070*</td> <td>SL101241X060*</td> </tr> <tr> <td>CH501820X080*</td> <td>CH501820X070*</td> <td>SL101361X080*</td> <td>SL101361X070*</td> </tr> <tr> <td>CH501101X080*</td> <td>CH501101X070*</td> <td>SL101391X080*</td> <td>SL101391X070*</td> </tr> <tr> <td>CH102080X060*</td> <td>CH102080X050*</td> <td>SL102680X060*</td> <td>SL102680X050*</td> </tr> <tr> <td>CH102100X060*</td> <td>CH102100X050*</td> <td>SL102121X100*</td> <td>SL102121X060*</td> </tr> <tr> <td>CH102120X060*</td> <td>CH102120X050*</td> <td>SL102151X100*</td> <td>SL102151X070*</td> </tr> <tr> <td>CH102620X080*</td> <td>CH102620X070*</td> <td>SL102181X100*</td> <td>SL102181X070*</td> </tr> <tr> <td>CH102820X100*</td> <td>CH102820X080*</td> <td>SL102201X100*</td> <td>SL102201X080*</td> </tr> <tr> <td></td> <td></td> <td>SL102221X100*</td> <td>SL102221X080*</td> </tr> </tbody> </table> 2. Complete lead code 3.Add last SAP code “ H” for halogen and Pb free , epoxy resin..	Before	Now	Before	Now	CH5000R5X040*	not available	SL500181X060*	SL500181X050*	CH1010R5X040*	not available	SL500241X070*	SL500241X060*	CH501360X050*	CH501360X060*	SL500361X080*	SL500361X070*	CH501620X080*	CH501620X060*	SL500391X080*	SL500391X070*	CH501680X080*	CH501680X060*	SL101181X060*	SL101181X050*	CH501750X080*	CH501750X060*	SL101241X070*	SL101241X060*	CH501820X080*	CH501820X070*	SL101361X080*	SL101361X070*	CH501101X080*	CH501101X070*	SL101391X080*	SL101391X070*	CH102080X060*	CH102080X050*	SL102680X060*	SL102680X050*	CH102100X060*	CH102100X050*	SL102121X100*	SL102121X060*	CH102120X060*	CH102120X050*	SL102151X100*	SL102151X070*	CH102620X080*	CH102620X070*	SL102181X100*	SL102181X070*	CH102820X100*	CH102820X080*	SL102201X100*	SL102201X080*			SL102221X100*	SL102221X080*	8-9 6-7 5
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2008.12.12	3	1. Complete the 13 th to 17 th codes of SAP P/N. 2. Page layout adjustment. 3. Added Marking when the coating resin is Halogen and PB free Epoxy.	5-9																																																												
2009.8.19	4	1 Change PSA & POE logo to Walsin & POE logo. 2.Operating temperature range change from -25℃ ~ +85℃ to -25℃ ~ +125℃, and the loading temperature of High Temperature Loading change from +85℃ to +125℃ (but the T.C.C temperature didn't change).	13 15																																																												
2010.8.24	5	1. Change the diameter dimension from 060 to 070 for P/N CH 500V 62pF&68pF&75pF. 2. Add 10pF~39pF(Code of diameter dimension is 050) for P/N SL 1KV.	8 9																																																												
2012/5/10	6	1). Review the size Dφ of the item CH/500V/121&151 from “100” to be “080”; 2). Review the size Dφ for the item CH/1000V/820 from “080” to be “070”, CH/1000V/101 from “100” to be “070”.	8 8																																																												
2012/12/5	7	Add 8.6. Ambient Temp of Allowable Voltage Graph (500Vdc to 2kVdc)	18-19																																																												
2013/5/6	8	1. Review the Lead diameter φ from 0.60 +/-0.06mm to 0.55+/-0.05mm 2. Review the “DΦ≤6.0mm shall be omitted.” to “ DΦ≤060 shall be omitted.” 3. Review the Solderability temperature from 255(+5/-0)℃ to 245±5℃ , Solderability time from 2 ±0.5s to 5±0.5s.	7,10 9 13																																																												
2013/10/18	9	Review the packing specification	11																																																												
2015/8/31	10	Modify the contents of the use of epoxy resin for 1KV products	8-9																																																												
2015/9/23	11	1. Modify the contents of the temperature characteristic. 2. Delete the definition about“Old Part No.”. 3. Delete 300 Pf~391 pF (Code of diameter dimension is 110&120) for P/N CH 50V&100V. 4. Delete 82 pF &100 pF (Code of diameter dimension is 070) and 120 pF &150 pF (Code of diameter dimension is 080) for P/N CH 500V. 5. Delete 56 pF &68pF~100pF (Code of diameter dimension is 070) for P/N CH 1KV. 6. Delete 4pF~22pF (Code of diameter dimension is 060) and 24pF~47pF (Code of diameter dimension is 070) for P/N CH 2KV.	5, 6,7 8 8 8 8																																																												
2016/3/2	12	1. Review the Available lead code of Lead Configuration. 2. Review 8.6. Ambient Temp of Allowable Voltage Graph (500Vdc to 2kVdc) 3. Review 9. Drawing of internal structure and material list	6-7 17-18 19																																																												



Date	Version	Description	page	
2016/5/3	13	1. Revised diameter as below :	9	
		Before		Now
		SL202181J100*		SL202181J080*
		SL202201J100*		SL202201J080*
		SL202221J100*		SL202221J080*
		SL202241J100*		SL202241J080*
		SL202271J100*		SL202271J080*
		SL202301J120*		SL202301J110*
SL202331J120*	SL202331J110*			
2016/11/3	14	1. Delete "CH" series.	5,8,12~13	
2016/12/21	15	1. Revised the product diameter for SL 50V~500V	8	

1. Part number for SAP system(total eighteen code) :

SL 102 470 J 050 B 20 C 5 H
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩

① Temperature characteristic :

SL: +350~-1000ppm/°C

② Rated voltage (Vdc) :

Voltage	50V	100V	500V	1000V	2000V
Code	500	101	501	102	202

③ Capacitance(pF) :

Capacitors (pF)	47	100	330	470	820
Code	470	101	331	471	821

④ Capacitance tolerance : D: ±0.5pF (For6~10pF) 、 J: ±5% (For above 10pF)

⑤ Nominal body diameter dimension :

Diameter size	4mm	5mm	6mm	7mm	8mm	9mm	10mm	11mm	12mm
Code	040	050	060	070	080	090	100	110	120

⑥ Code of lead type : Please refer to Item “2.Mechanical”.

⑦ Packing mode and lead's length (identified by 2-figure code)

Taping Code	Description
AN	Ammo / Pitch of component:12.7 mm

Bulk Code	Description
3E	Lead's length L : 3.5mm
04	Lead's length L : 4mm
4E	Lead's length L : 4.5mm
20	Lead's length L : 20mm

⑧ Length tolerance

Code	Description
A	±0.5 mm(Only for short kink lead code)
B	±1.0 mm
C	Min.
D	Taping special purpose

⑨ Pitch

Code	Description	Code	Description
5	5.0±0.8mm (For Bulk)	7	7.5 ±1mm
5	5.0+0.8mm-0.2mm (For Taping)	0	10.0 ±1mm
2	2.5 ±0.8 mm		

⑩ Coating code

Code	Description
P	Phenolic resin -Pb free
A	Halogen free and Pb free, phenolic resin
B	Epoxy Resin , Pb free
H	Halogen free and Pb free , epoxy resin

2. Mechanical:
Available lead code: (unit: mm)

Lead type	SAPP/N (13-17) digits	Pitch (F)	Lead length (L)	Available rated voltage	Packing	Lead configuration
Lead style : B Straight long lead	B20C2	2.5 ± 0.8	20 MIN.	50V&100V	Bulk	
	B20C5	5.0 ± 0.8	20 MIN.			
	B20C6	6.4 ± 1.0	20 MIN.	50V&100V, 500V, 1KV,2KV		
	B20C0	10 ± 1.0	20 MIN.			
	B20C7	7.5 ± 1.0	20 MIN.			
	BAND5	5.0 ^{+0.8} _{-0.2}	Taping Spec. (Ref. to page.10)			
BAND2	2.5 ± 0.8					
Lead style : L Straight short lead	L05B2	2.5 ± 0.8	5.0 ± 1.0	50V&100V, 500V, 1KV, 2KV	Bulk	
	L05B5	5.0 ± 0.8	5.0 ± 1.0			
	L05B0	10 ± 1.0	5.0 ± 1.0			
	L05B6	6.4 ± 1.0	5.0 ± 1.0			
	L05B7	7.5 ± 1.0	5.0 ± 1.0			
	L4EB5	5.0 ± 0.8	4.5 ± 1.0			
	L4EB7	7.5 ± 1.0	4.5 ± 1.0			
L4EB0	10 ± 1.0	4.5 ± 1.0				
Lead style : H Inside kink lead	H3EA5	5.0 ± 0.8	3.5 ± 0.5	50V&100V, 500V, 1KV	Bulk	
	H04A5	5.0 ± 0.8	4.0 ± 0.5			
	H4EB5	5.0 ± 0.8	4.5 ± 1.0			
	H05B5	5.0 ± 0.8	5.0 ± 1.0		Tap. Ammo	
	H20C5	5.0 ± 0.8	20 MIN.			
	HAND5	5.0 ^{+0.8} _{-0.2}	Taping SPEC. (Ref. to page.10)	50V&100V, 500V, 1KV,2KV	Bulk	
	H05B7	7.5 ± 1.0				
	H05B0	10 ± 1.0	5.0 ± 1.0			
	H20C0	10 ± 1.0	20 MIN.			
	H04A7	7.5 ± 1.0	4.0 ± 0.5			
	H04A0	10 ± 1.0	4.0 ± 0.5			
	H3EA7	7.5 ± 1.0	3.5 ± 0.5			
	H3EA0	10 ± 1.0	3.5 ± 0.5			
H4EB7	7.5 ± 1.0	4.5 ± 1.0				
H4EB0	10 ± 1.0	4.5 ± 1.0				
Lead style : X Outside kink lead	X3EA5	5.0±0.8	3.5 ± 0.5	50V&100V, 500V, 1KV, 2KV	Bulk	
	X3EA7	7.5±1.0				
	X3EA0	10±1.0				
	X04A5	5.0±0.8	4.0 ± 0.5			
	X04A7	7.5±1.0				
	X04A0	10±1.0				
	X05B5	5.0±0.8	5.0 ± 1.0			
	X05B7	7.5±1.0				
X05B0	10±1.0					
Lead style : D Vertical kink short lead	D04A5	5.0±1.0	4.0 ± 0.5	50V&100V, 500V, 1KV, 2KV	Bulk	
	D04A7	7.5±1.0				
	D04A0	10±1.0				
	D3EA5	5.0±0.8	3.5 ± 0.5			
	D3EA7	7.5±1.0				
	D3EA0	10±1.0				
	DAND5	5.0 ^{+0.8} _{-0.2}			Taping SPEC. (Ref. to page.10)	

Lead type	SAPP/N (13-17) digits	Lead length (L)	Available rated voltage	Packing	Lead configuration
Lead style : M Double outside kink lead	M05B5	5.0 ± 1.0	50V&100V, 500V, 1KV, 2KV	Bulk	
	M05B7				
	M05B0				
	M04B5	4.0 ± 1.0			
	M04B7				
	M04B0				

※ Lead diameter $\phi = 0.55 \pm 0.05$ mm

※ Phenolic resin coating for 50V/500V/1KV product; Epoxy resin coating for 1KV or 2KV product.

※ **e** (Coating **extension** on leads):

For straight lead style: 1.5mmMax when the rated voltage is 50Vdc & 100Vdc;

2.0mmMax when the rated voltage is 500Vdc and 1KVdc;

3.0mmMax when the rated voltage is 2KVdc.

For kink lead style: not exceed the kink.

※ When $D\phi \geq 11$ mm, only for bulk, but $D\phi \leq 10$ mm can do Bulk or Taping.

3. Capacitance value vs. rated voltage, product diameter:

T.C Rate voltage	SL																				
	50V/100V							500V					1KV				2KV				
Dφ	040	050	060	070	080	090	100	050	060	070	080	100	050	060	070	080	060	070	080	110	
D max. (mm)	5.0	6.0	7.0	8.0	9.0	10.0	11.0	6.0	7.0	8.0	9.0	11.0	6.0	7.0	8.0	9.0	7.5	8.5	9.5	12.5	
T max. (mm)	3.5	3.5	3.5	3.5	3.5	3.5	3.5	4.0	4.0	4.0	4.0	4.0	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	
2																					
3																					
4																					
5																					
6																					
7																					
8	080							080													
10	100							100					100								
12	120							120					120								
15	150							150					150					150			
18	180							180					180					180			
20	200							200					200					200			
22	220							220					220					220			
24	240							240					240					240			
27	270							270					270					270			
30	300							300					300					300			
33	330							330					330					330			
36	360							360					360					360			
39	390							390					390					390			
47	470							470					470					470			
51	510							510					510					510			
56	560							560					560					560			
68	680							680					680					680			
75	750							750					750					750			
82	820							820					820					820			
100	101							101					101					101			
120		121							121										121		
150		151							151										151		
180		181								181						181				181	
200			201							201							201			201	
220			221							221							221			221	
240			241								241							241		241	
270				271							271								271		
300				301							301									301	
330				331							331									331	
360				361								361									
390				391								391									
470					471																
500						501															
510						511															
560						561															
680							681														
750							751														
820							821														
PACKING	TAPING or BULK							TAPING or BULK					TAPING or BULK				TAPING or BULK				BULK
COATING	Phenolic resin													Phenolic resin or Epoxy Resin				Epoxy Resin			

4. Marking:

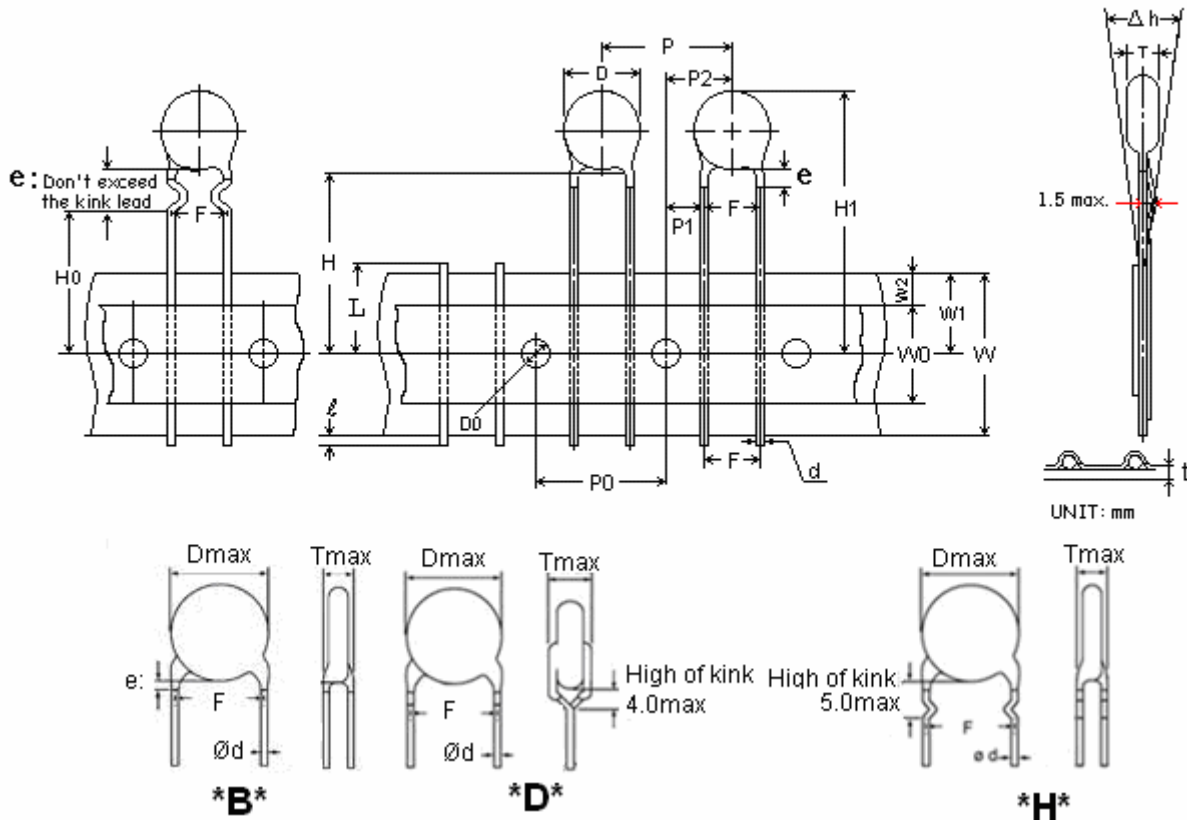
Marking	SL	
	Remarks	
(1). Temp. char.	SL : No marking.	
(2). Rated capacitance	Identified by 3-Figure Code. Ex. 47pF→"47" , 470pF→"471"	
(3). Rated voltage	50V&100V	Marked with code " _ " under the rated capacitance.
	500V	No any marking under the rated capacitance.
	1000V&2000V	Marked with code: 1000V→"1KV" , 2000V→"2KV"
(4). Capacitance tolerance	C: ±0.25pF (For below 5pF) 、 D: ±0.5pF (For6~10pF) 、 J: ±5% (For above 10pF)	
(5). Manufacturer's identification	Shall be marked as "UK", but Dφ≤060 shall be omitted.	
(6). Halogen and Pb free	There is a " _ "marking under the code "V" when the coating resin is Halogen and Pb free Epoxy.	

5. Taping specifications:

* Lead spacing: $F=5.0^{+0.8}_{-0.2}$ (mm)

• 12.7mm pitch/lead spacing 5.0mm taping

Lead code: *BAND5 & *DAND5 & *HAND5



Item	Symbol	Specification		Remarks	
		Value	Tolerance		
Body diameter	D	*	max.	See Section "3. Capacitance value vs. rated voltage, product diameter".	
Body thickness	T	*	max.		
Lead-wire diameter	d	0.55	±0.05		
Pitch of component	P	12.7	±1.0		
Feed hole pitch	P0	12.7	±0.3	Cumulative pitch error: 1.0mm/20 pitch	
Feed hole center to lead	P1	3.85	±0.7	To be measured at bottom of clinch	
Hole center to component center	P2	6.35	±1.3		
Lead-to-lead distance	F	5.0	+0.8,-0.2		
Component alignment, F-R	Δh	0	±2.0		
Tape width	W	18.0	+1.0,-0.5		
Hole-down tape width	W0	8.0	min.		
Hole position	W1	9.0	+0.75,-0.5		
Hole-down tape position	W2	3.0	max.		
Height of component form tape center	For straight lead type	H	20.0	+1.0 -0.5	
	For kinked lead type	H0	16.0	±0.5	
Component height	H1	32.25	max.		
Lead-wire protrusion	l	2.0	max.	Or the end of lead wire may be inside the tape.	
Food hole diameter	D0	4.0	±0.2		
Total tape thickness	t	0.7	±0.2	Ground paper: 0.5±0.1mm	
Length of sniped lead	L	11.0	max.		
Coating rundown on leads	e	Please refer to page 6 "e(Coating extension on leads)".			

6. Packing Baggage :

6.1 Packing size:

Type	Box	Carton
Bulk		
Ammo taping		

6.2 Packing quantity:

Packing Type	The code of 14th to 15th in SAP P/N		MPQ (Kpcs/Box)	Remark	
Taping	AN		2	Phenolic resin	
	AN		1.5	Epoxy resin	
Packing Type	Lead length	Size code of 10th to 12th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box	Remark
Bulk	Long lead (L ≥ 16mm)	040~070	1	3	Phenolic resin
		080~100	1	2	Phenolic resin
		050~100	1	2	Epoxy resin
	Short lead (L < 16mm)	110~120	0.5	1.5	
		040~060	1	6	
		070~080	1	4	
		090~100	1	3	
	110~120	1	2		

7. Specification and test method:

7.1 SCOPE: THIS SPECIFICATION APPLIES TO TEMPERATURE COMPENSATING CERAMIC DISC CAPACITOR.

7.2 TEST CONDITIONS :

UNLESS OTHERWISE SPECIFIED, ALL TESTS SHALL BE OPERATED AT THE STANDARD TEST CONDITIONS OF TEMPERATURE 5°C TO 35°C AND RELATIVE HUMIDITY 45% TO 85%. WHEN FAILS A TEST, RETEST BE OPERATED AT THE CONDITIONS OF TEMPERATURE 25°C ± 2°C, RELATIVE HUMIDITY OF 60% TO 70% AND BAROMETRIC PRESSURE 860 TO 1060 MBAR.

7.3 HANDLE PROCEDURE : TO AVOID UNEXPECT TESTING RESULTS FROM OCCURRING, THE TESTED CAPACITOR MUST BE KEPT AT ROOM TEMPERATURE FOR AT LEAST 30 MINUTES AND COMPLETELY DISCHARGED.

7.4 TEST ITEMS :

ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
APPEARANCE STRUCTURE SIZE	NO ABNORMALITIES	AS SECTION 3.
MARKING		AS STATED IN SECTION 4
WITHSTAND VOLTAGE	BETWEEN TERMINALS: NO ABNORMALITIES	A. BELOW 1KV: 300% RATED VOLTAGE WITH 50mA MAX. CHARGING CURRENT FOR 1~5 SEC. B. 1KV & ABOVE: 200% RATED VOLTAGE WITH 50mA MAX. CHARGING CURRENT FOR 1~5 SEC.
	BETWEEN TERMINAL AND ENCLOSURE : NO ABNORMALITIES	SMALL METALLIC BALLS WITH 1mm DIAMETERS SHALL BE PUT ON A VESSEL AND THE TEST CAPACITOR SHALL BE SUBMERGED EXCEPT 2mm FROM THE TOP OF ITS COMPONENT BODY. THE TEST VOLTAGE SHALL BE APPLIED BETWEEN THE SHORT-CIRCUITED TERMINALS AND THE METALLIC BALLS. (APPLY 1.3KV DC OF RATED VOLTAGE BETWEEN TERMINALS AND ENCLOSURE FOR 1~5 SEC)
INSULATION RESISTANCE	10000 MΩ MIN	INSULATION RESISTANCE SHALL BE MEASURED AT 60±5 SECONDS AFTER APPLIED VOLTAGE (RATED) RATED VOLTAGE: 50V=50V, 100V=100V, 500V & ABOVE=500V
CAPACITANCE	TOLERANCE : C : ±0.25PF D : ±0.50PF J : ±5% K : ±10%	TESTING FREQUENCY : 1 MHZ ± 20% TESTING VOLTAGE : 1.0 VRMS
OPERATING TEMPERATURE RANGE	-25°C ~ +125°C	
Q FACTOR	30 PF & ABOVE	$Q \geq 1000$
	BELOW 30PF	$Q \geq 400+20 \times C$
		AS ABOVE STIPULATION OF CAPACITANCE

ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE												
TEMPERATURE CHARACTERISTIC	TEMPERATURE COEFFICIENT : SL :+350~-1000 ppm/°C FOR (+20°C~+85°C)	ACCORDING TO STEP 1 TO 5 IN ORDER, MEASURED CAPACITANCE WHEN TEMPERATURE REACH BALANCE AND TEMPERATURE COEFFICIENT SHALL BE CALCULATED ON THE FOLLOWING FORMULA : $\text{PPM}/^{\circ}\text{C} = (\text{C2}-\text{C1}) \times 10^6 / \text{C1}(\text{T2}-\text{T1})$ <table border="1" data-bbox="802 555 1417 656"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> <th>5</th> </tr> </thead> <tbody> <tr> <td>Temp. (°C)</td> <td>20±2</td> <td>-25±3</td> <td>20±2</td> <td>85±2</td> <td>20±2</td> </tr> </tbody> </table> NOTE : C1 = CAPACITANCE AS STEP 3 C2 = CAPACITANCE AS STEP 2 OR 4 T1 = TEMPERATURE AS STEP 3 T2 = TEMPERATURE AS STEP 2 OR 4	Step	1	2	3	4	5	Temp. (°C)	20±2	-25±3	20±2	85±2	20±2
	Step	1	2	3	4	5								
Temp. (°C)	20±2	-25±3	20±2	85±2	20±2									
CAPACITANCE TOLERANCE : WITHIN ±0.2% OR ±0.05PF, WHICHEVER IS LARGE	ACCORDING TO ABOVE STEP 1,3 & 5, CAPACITANCE TOLERANCE SHALL BE CALCULATED ON THE FOLLOWING FORMULA : $\Delta\text{C}\% = (\text{G} - \text{S}) / \text{C1}$ NOTE : G = GREATEST CAPACITANCE AS TESTING RESULT OF STEP 1,3 & 5 S = LEAST CAPACITANCE AS TESTING RESULT OF STEP 1,3 & 5 C1 = CAPACITANCE AS STEP 3													
TERMINAL STRENGTH	TENSIBLE STRENGTH : NO BREAKDOWN	WIRE DIA.0.5 M/M. LOADING WEIGHT 0.5 KGS, FOR 10±1 SECONDS. WIRE DIA.0.6 M/M. LOADING WEIGHT 1.0 KGS, FOR 10±1 SECONDS.												
	BENDING STRENGTH : NO BREAKDOWN	WIRE DIA.0.5 mm, LOADING WEIGHT 0.25 KGS. WIRE DIA.0.6 mm, LOADING WEIGHT 0.5 KGS. (BENDING BACK AND FORTH 90 DEGREE TWICE)												
SOLDERING HEAT RESISTANCE	APPEARANCE : NO ABNORMALITIES	LEAD WIRE OR TERMINALS SHALL BE IMMERSUED UP TO 2.0 M/M FORM BODY. (A) BODY DIA. ≤5.0mm: INTO THE MOLTEN SOLDER OF WHICH TEMPERATURE: 260(+5/-0)°C FOR 3.0±0.5 SECONDS.												
	CAP.CHANGE : WITHIN ±2.5% OR ±0.25PF, WHICHEVER IS LARGE.	(B) BODY DIA. >5.0mm: INTO THE MOLTEN SOLDER OF WHICH TEMPERATURE 260(+5/-0)°C FOR 5~10 SECONDS.												
	WITHSTAND VOLTAGE : (BETWEEN TERMINALS) NO ABNORMALITIES	THEN LEAVE AT STANDARD TEST CONDITIONS FOR 1~2 HOURS, THEN MEASURED. ※WHEN SOLDERING CAPACITOR WITH A SOLDERING IRON, IT SHOULD BE PERFORMED IN FOLLOWING CONDITIONS. TEMPERATURE OF IRON-TIP: 350~400 °C SOLDERING IRON WATTAGE : 50W MAX. SOLDERING TIME : 3.5 SEC. MAX.												
SOLDERABILITY	LEAD WIRE SHALL BE SOLDERED OVER 75% OF THE CIRCUMFERENTIAL DIRECTION.	TO COMPLY WITH JIS-C-5102 8.4 SOLDER TEMPERATURE 245±5°C AND DIPPING TIME 5±0.5 SECONDS FLUX : WEIGHT RATIO OF ROSIN 25%												

ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
HUMIDITY CHARACTERISTIC	APPEARANCE : NO ABNORMALITIES	CAPACITORS SHALL BE SUBJECTED TO A RELATIVE HUMIDITY OF 90 ~ 95% AT 40 ± 2°C FOR 500(+24/-0) HOURS, THEN DRIED FOR 1~2 HOURS AND MEASURED.
	CAP. CHANGE : SL : WITHIN ±5% OR ±0.5PF, WHICHEVER IS LARGE	
	Q FACTOR : SL : LESS THAN 10PF ==> $Q \geq 200 + 10 \times C$ MORE THAN 10PF AND LESS THAN 30PF => $Q \geq 275 + 5 \times C / 2$ MORE THAN 30PF => $Q \geq 350$	
	INSULATION RESISTANCE : 1000MΩ MIN.	
HUMIDITY LOADING	APPEARANCE : NO ABNORMALITIES	CAPACITORS SHALL BE SUBJECTED TO A RELATIVE HUMIDITY OF 90 ~ 95% AT 40±2°C FOR 500(+24/-0) HOURS WITH RATED VOLTAGE APPLIED (LESS THAN 50mA), THAN DRIED FOR 1~2 HOURS AND MEASURED.
	CAP.CHANGE : SL : WITHIN ±7.5% OR ±0.75PF, WHICHEVER IS LARGE	
	Q FACTOR : SL : LESS THAN 30PF => $Q \geq 100 + 10 \times C / 3$ MORE THAN 30PF => $Q \geq 200$	
	INSULATION RESISTANCE : 500MΩ MIN.	
HIGH TEMPERATURE LOADING	APPEARANCE : NO ABNORMALITIES	CAPACITORS SHALL BE SUBJECTED TO A TEST OF: (A) BELOW 1KV: 200% RATED VOLTAGE WITH 50mA MAX. (B) 1KV & ABOVE: 150% RATED VOLTAGE WITH 50mA MAX. FOR 1000(+48/-0) HOURS AT 125°C ± 2°C (FOR CH & SL) AND THEN DRIED FOR 1~2 HOURS AND MEASURED.
	CAP. CHANGE : SL : WITHIN ±3% OR ±0.3PF, WHICHEVER IS LARGE	
	Q FACTOR : SL : LESS THAN 10PF => $Q \geq 200 + 10 \times C$ MORE THAN 10PF & LESS THAN 30PF => $Q \geq 275 + 5 \times C / 2$ MORE THAN 30PF => $Q \geq 350$	
	INSULATION RESISTANCE : 1000MΩ MIN.	

ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
TEMPERATURE CYCLING	APPEARANCE : NO ABNORMALITIES	CAPACITORS SHALL BE SUBJECTED TO: -25±3°C (30±3min) → 25°C (3min) → 125±3°C (30±3min) → 25°C (3min) FOR 5 CYCLE.
	CAP. CHANGE : WITHIN ±5% OR ±0.5PF, WHICHEVER IS LARGE	
	D.F. $C < 30\text{pF} : Q \geq 275 + (5/2)C$ $C \geq 30\text{pF} : Q \geq 350$	
	INSULATION RESISTANCE : 1000 MΩ MIN.	

8. Cautions & notices:

8.1. Caution (Rating)

I. Operating Voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the V_{p-p} value of the applied voltage or the V_{0-p} which contains DC bias within the rated voltage range.

When the voltage is applied to the circuit, starting or stopping may generate irregular voltage for a transit period because of resonance or switching. Be sure to use a capacitor with a rated voltage range that includes these irregular voltages.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage (1)	Pulse Voltage (2)
Positional measurement					

II. Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high frequency current, pulse current or similar current, it may self-generate heat due to dielectric loss. The frequency of the applied sine wave voltage should be less than 100kHz. The applied voltage load (*) should be such that the capacitor's self-generated heat is within 20°C at an atmosphere temperature of 25°C. When measuring, use a thermocouple of small thermal capacity-K of $\phi 0.1\text{mm}$ in conditions where the capacitor is not affected by radiant heat from other components or surrounding ambient fluctuations.

Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. (Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.)

III. Fail-Safe

When capacitor is broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

8.2. Caution (Storage and operating condition)

I. Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 degrees centigrade and 15 to 85 % for 6 months maximum and use within the period after receiving the capacitors.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.

8.3. Caution (Soldering and Mounting)

I. Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

II. Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor.

Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element. When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage : 50W max.

Soldering time : 3.5 sec. max.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.

8.4. Caution (Handling)

Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRDUCT IS USED.

8.5. Notice

8.5.1. Notice (Soldering and Mounting)

Cleaning (ultrasonic cleaning)

To perform ultrasonic cleaning, observe the following conditions.

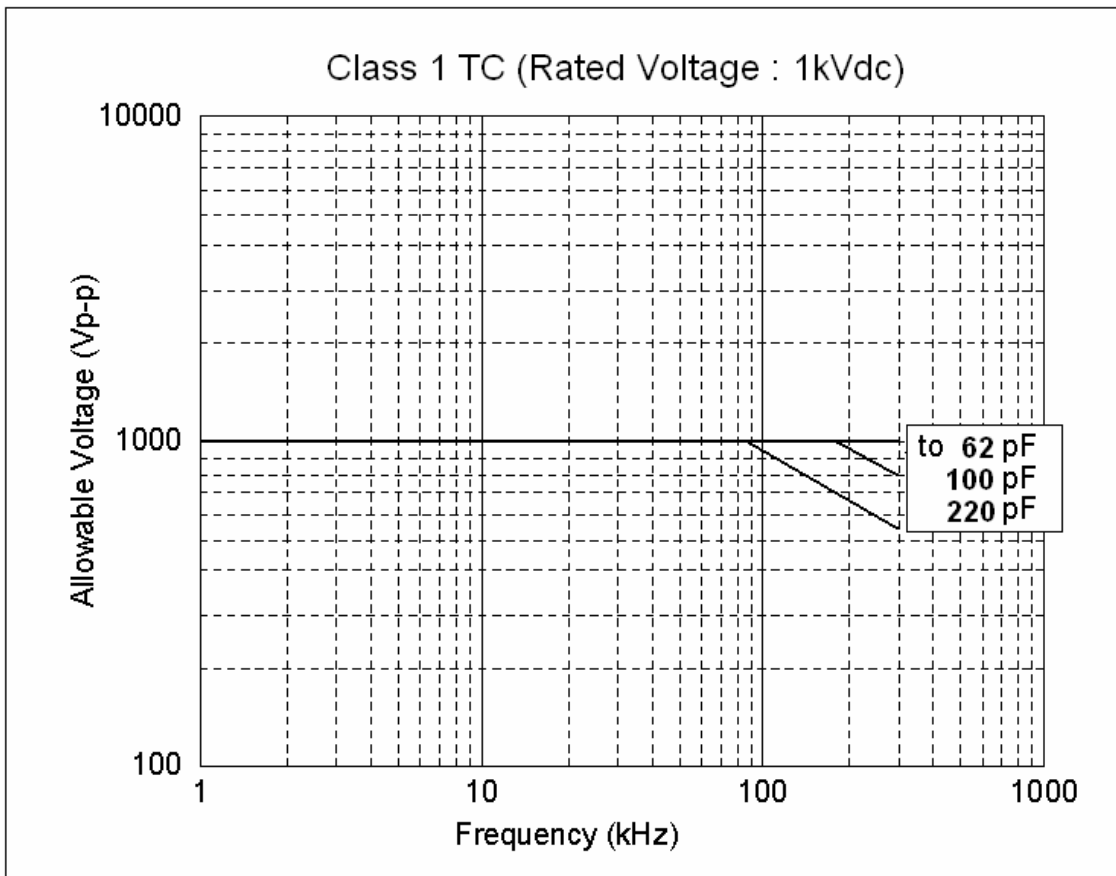
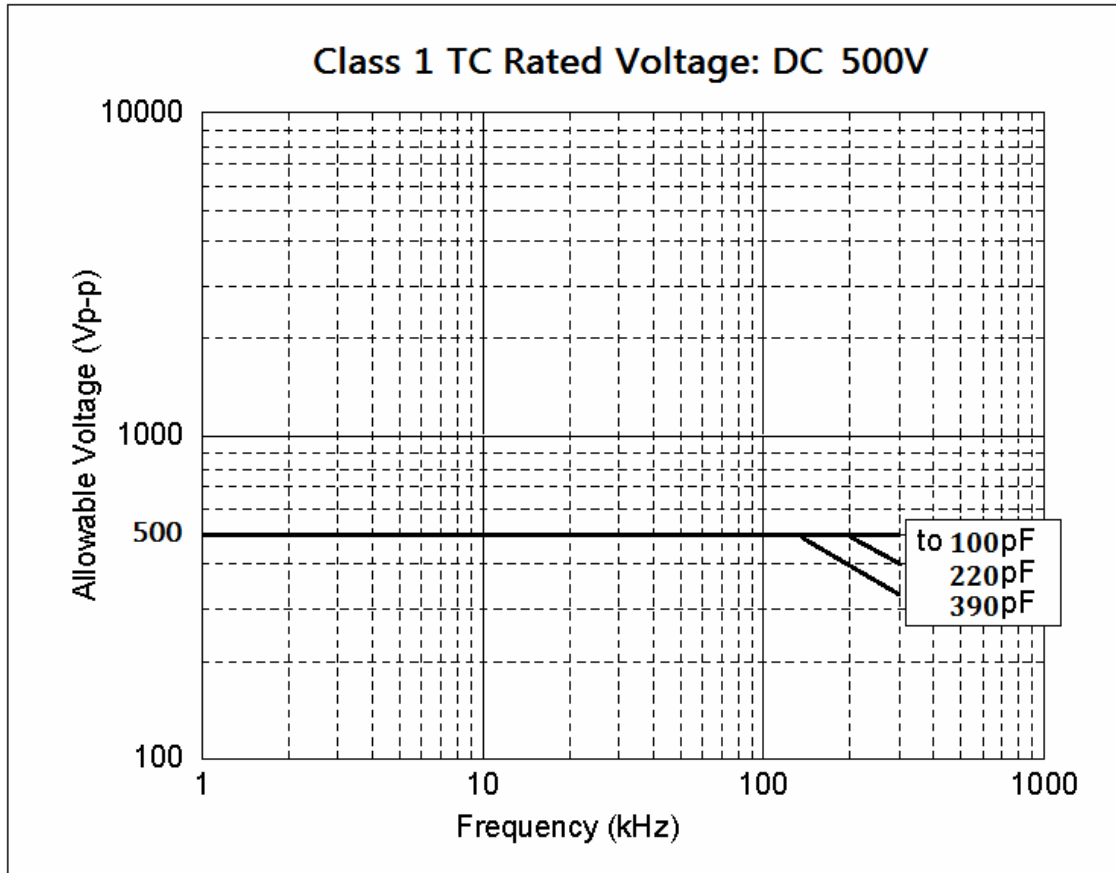
Rinse bath capacity : Output of 20 watts per liter or less.

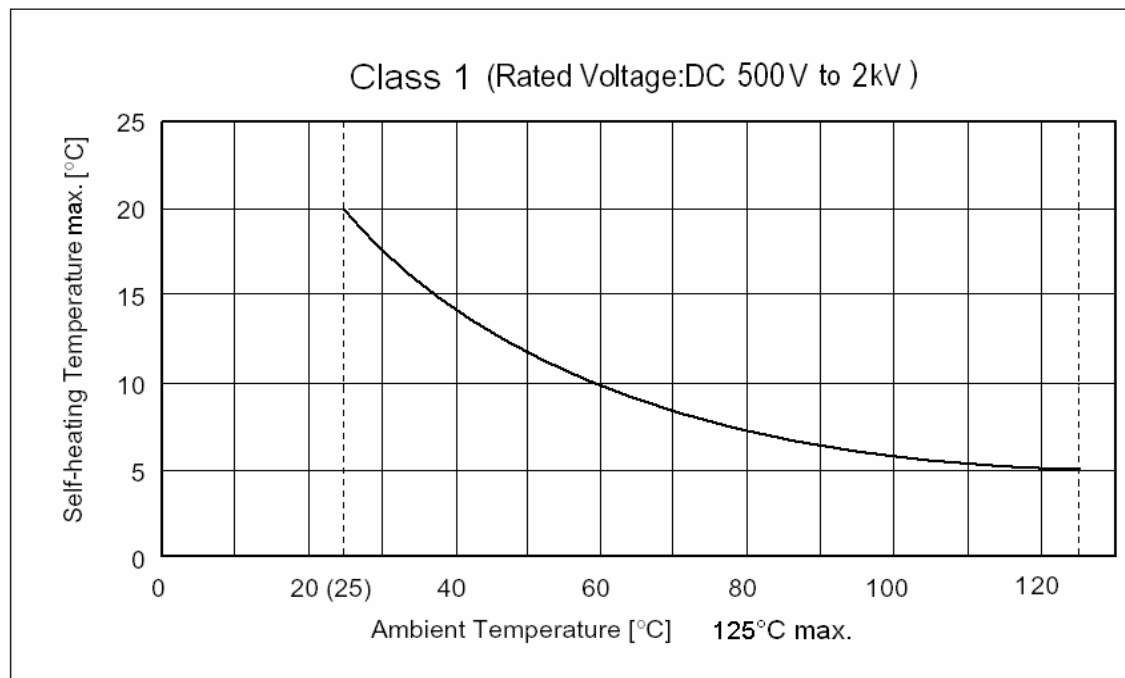
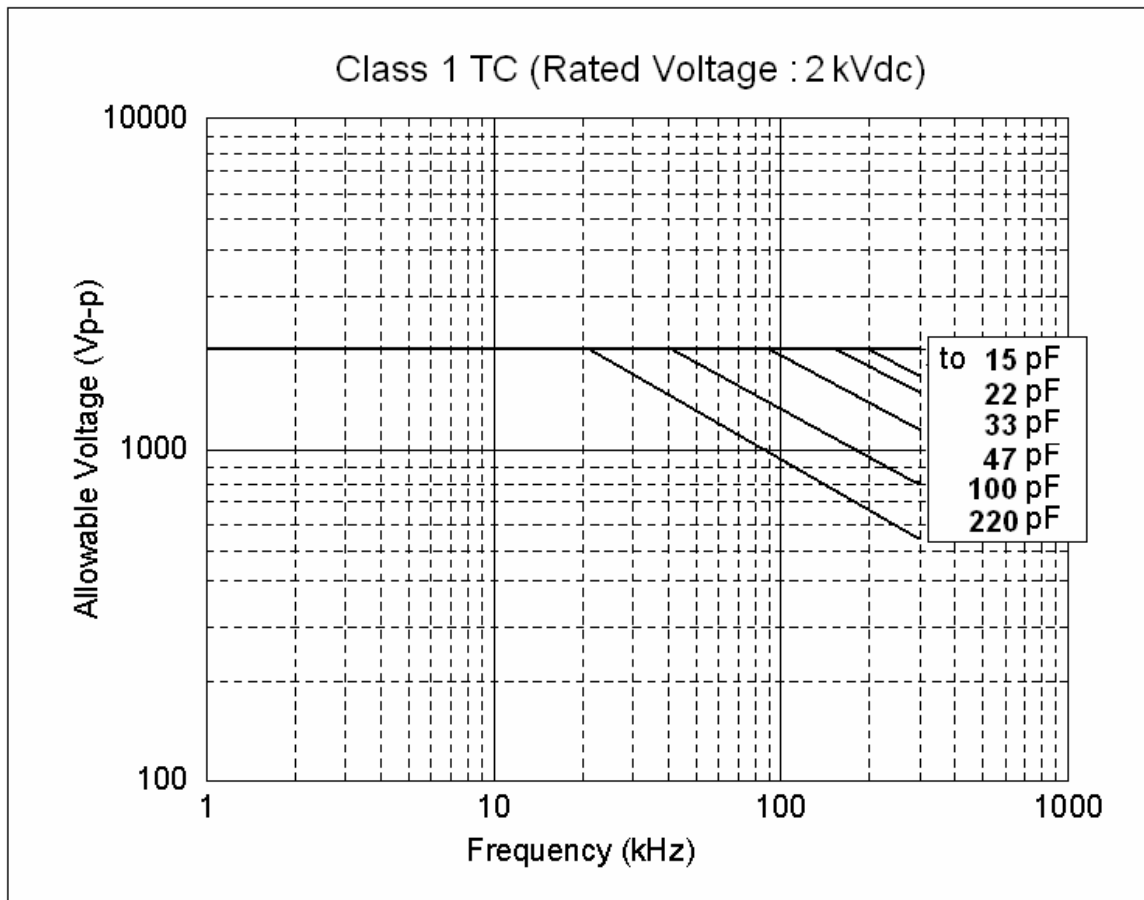
Rinsing time : 5 min. maximum.

Do not vibrate the PCB/PWB directly.

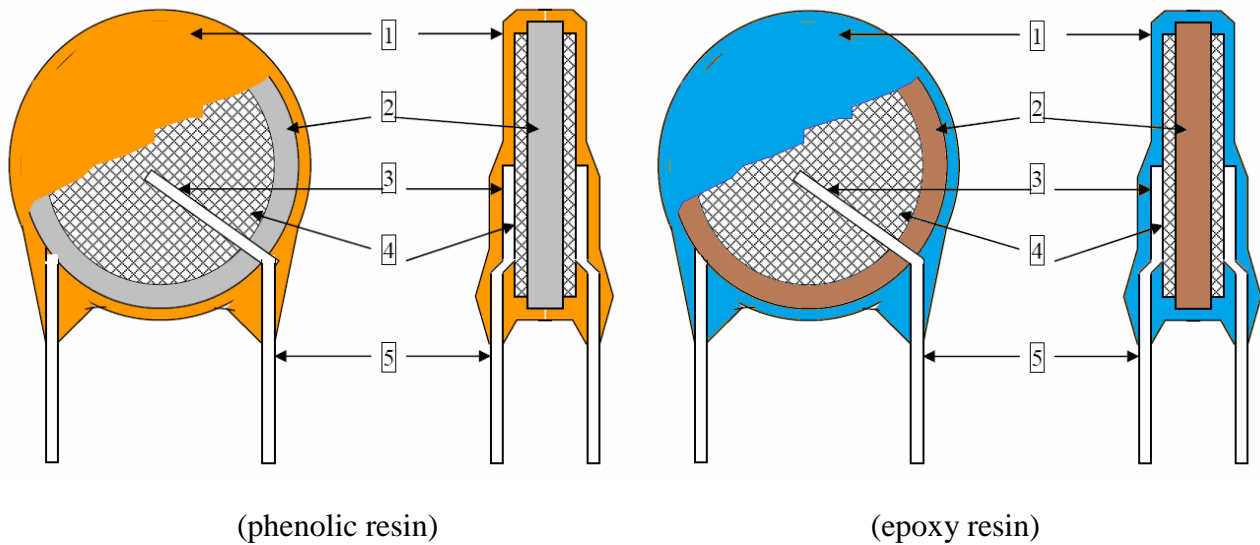
Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

8.6. Ambient Temp of Allowable Voltage Graph (500Vdc to 2kVdc)





The ambient temperature and the surface temperature of capacitor must be 125°C or lower.
 (Including self-heating.)

9. Drawing of internal structure and material list :


NO.	部位 Part name	材質 Material	構成部份 Component	供應商 Vendor
1	Insulation Coating	Phenolic resin Epoxy resin	Phenolic resin, Filler, Pigment Epoxy resin, SiO ₂ , TiO ₂	Namics Kai Hua
2	Dielectric Element	Ceramic	BaTiO ₃	Hua Xing Wang Feng Fenghua
3	Solder	Tin-silver	Sn97.5-Ag2.5	Huajun Haili
4	Electrodes	Ag	Silver, Glass frit	Daejoo Xinguang
5	Leads wire	Tinned copper clad steel wire	Substrate metal: Fe&Cu Surface plating: Sn 100%	Hengtai Wuhu Taililai